

#### **Features**

- UL recognition, file #E230084
- Glass passivated chip junction
- Ideal for printed circuit boards
- High surge current capability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

#### **Typical Applications**

General purpose use in AC/DC bridge full wave rectification for monitor, TV, printer, power supply, switching mode power supply, adapter, audio equipment, and home appliances applications.

#### **Mechanical Data**

• Package: GBU

Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant

• **Terminals**: Tin plated leads, solderable per

J-STD-002 and JESD22-B102
• Polarity: As marked on body

# ■Maximum Ratings (T<sub>a</sub>=25°C Unless otherwise specified)

- Maximum Ratings (	■Maximum Ratings (Ta-25 € Offiess offierwise specified)					
PARAMETER		SYMBOL	UNIT	GBU2516		
Device marking code				GBU2516		
Maximum Repetitive Peak Reverse Voltage		VRRM	V	1600		
Maximum RMS Voltage		VRMS	V	1120		
Maximum DC blocking Voltage		VDC	V	1600		
Average rectified output current @60Hz sine wave, R-load	With heatsink Tc =80°C	Ю	A	25.0		
	Without heatsink Ta =25℃			3.0		
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave,1 cycle, Tj=25°C		IFSM	Α	280		
Current squared time @1ms≤t≤8.3ms Tj=25°C, Rating of per diode		l²t	A <sup>2</sup> S	325		
Storage temperature		T <sub>stg</sub>	°	-55 ~ +150		
Junction temperature		Tj	$^{\circ}$	-55 ~ <b>+</b> 150		
Dielectric strength @ Terminals to case, AC 1 minute		Vdis	KV	2.5		
Mounting torque @Recommend torque: 5kg·cm		Tor	kg·cm	8		



# **GBU2516**

**■Electrical Characteristics** (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	GBU2516
Maximum instantaneous forward voltage drop per diode	VF	>	IFM=12.5A	1.1
Maximum DC reverse current at rated DC blocking voltage	IR	μА	T <sub>j</sub> =25°C	5
per diode			T <sub>j</sub> =125°C	500
Typical junction capacitance	Cj	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C	

# **■Thermal Characteristics** $(T_a=25 \degree C \text{ Unless otherwise specified})$

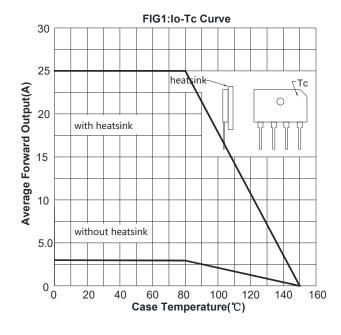
PARAMETER		SYMBOL	UNIT	GBU2516
Thermal	Between junction and ambient, Without heatsink	R <sub>0</sub> J-A	°C/W	25.0
Resistance	Between junction and case, With heatsink	RøJ-C		1.8

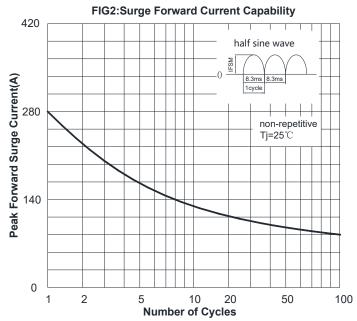
Note: Device mounted on 75mm x 45mm x 5.5mm Aluminum Plate Heatsink.

**■Ordering Information** (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
GBU2516	B1	Approximate 3.97	20	1000	2000	TUBE

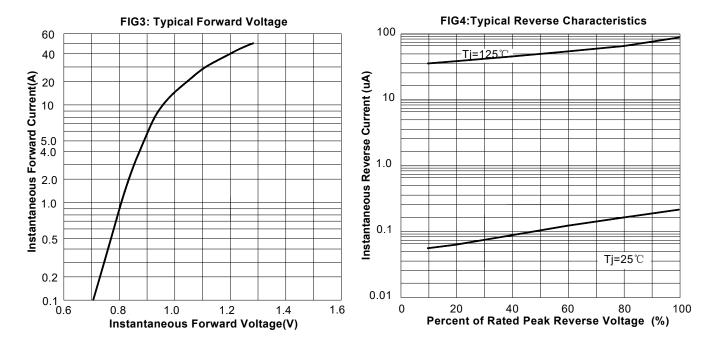
### **■ Characteristics** (Typical)



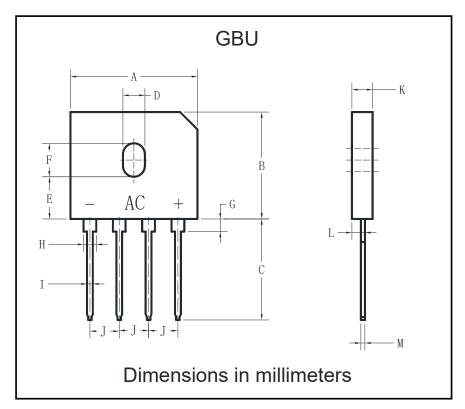








#### **■ Outline Dimensions**



GBU						
Dim	Min	Max				
Α	21.80	22.30				
В	18.30	18.80				
С	17.50	18.00				
D	3.30	3.90				
Е	7.10	7.50				
F	5.50	5.90				
G	1.91	2.54				
Н	2.06	2.54				
I	1.02	1.27				
J	4.83	5.33				
K	3.30	3.56				
L	2.40	2.66				
М	0.46	0.56				



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